

# SN74AVC16722 22-BIT FLIP-FLOP WITH 3-STATE OUTPUTS

SCES166H – DECEMBER 1998 – REVISED JUNE 2000

- Member of the Texas Instruments **Widebus™** Family
- **EPIC™** (Enhanced-Performance Implanted CMOS) Submicron Process
- **DOC™** (Dynamic Output Control) Circuit Dynamically Changes Output Impedance, Resulting in Noise Reduction Without Speed Degradation
- Dynamic Drive Capability Is Equivalent to Standard Outputs With  $I_{OH}$  and  $I_{OL}$  of  $\pm 24$  mA at 2.5-V  $V_{CC}$
- Overvoltage-Tolerant Inputs/Outputs Allow Mixed-Voltage-Mode Data Communications
- $I_{off}$  Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class I
- Packaged in Thin Shrink Small-Outline Package

## description

A Dynamic Output Control (DOC) circuit is implemented, which, during the transition, initially lowers the output impedance to effectively drive the load and, subsequently, raises the impedance to reduce noise. Figure 1 shows typical  $V_{OL}$  vs  $I_{OL}$  and  $V_{OH}$  vs  $I_{OH}$  curves to illustrate the output impedance and drive capability of the circuit. At the beginning of the signal transition, the DOC circuit provides a maximum dynamic drive that is equivalent to a high-drive standard-output device. For more information, refer to the TI application reports, *AVC Logic Family Technology and Applications*, literature number SCEA006, and *Dynamic Output Control (DOC™) Circuitry Technology and Applications*, literature number SCEA009.

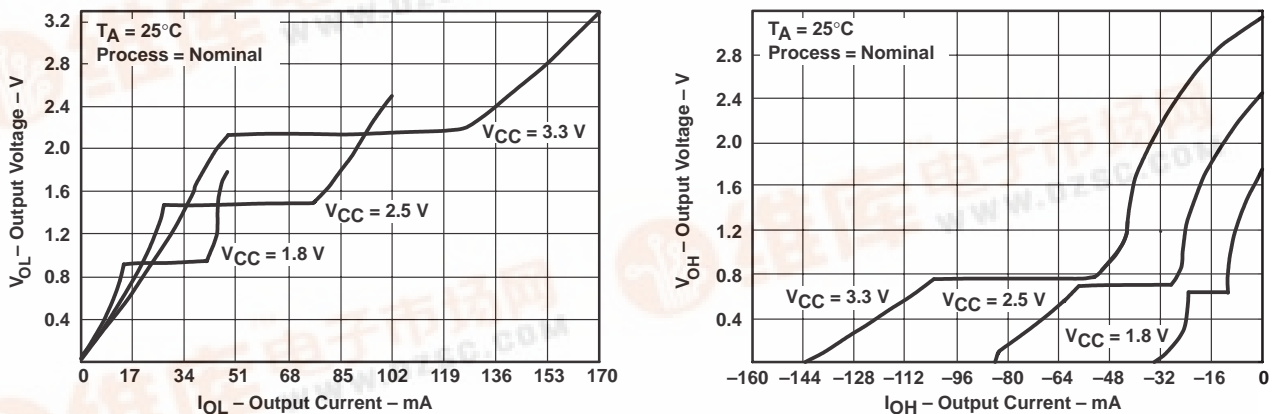


Figure 1. Output Voltage vs Output Current

This 22-bit flip-flop is operational at 1.2-V to 3.6-V  $V_{CC}$ , but is designed specifically for 1.65-V to 3.6-V  $V_{CC}$  operation.

The 22 flip-flops of the SN74AVC16722 are edge-triggered D-type flip-flops with clock-enable ( $\overline{\text{CLKEN}}$ ) input. On the positive transition of the clock (CLK) input, the device stores data into the flip-flops if  $\overline{\text{CLKEN}}$  is low. If  $\overline{\text{CLKEN}}$  is high, no data is stored.

A buffered output-enable ( $\overline{\text{OE}}$ ) input places the 22 outputs in either a normal logic state (high or low) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly.  $\overline{\text{OE}}$  does not affect the internal operation of the flip-flops. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



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description (continued)

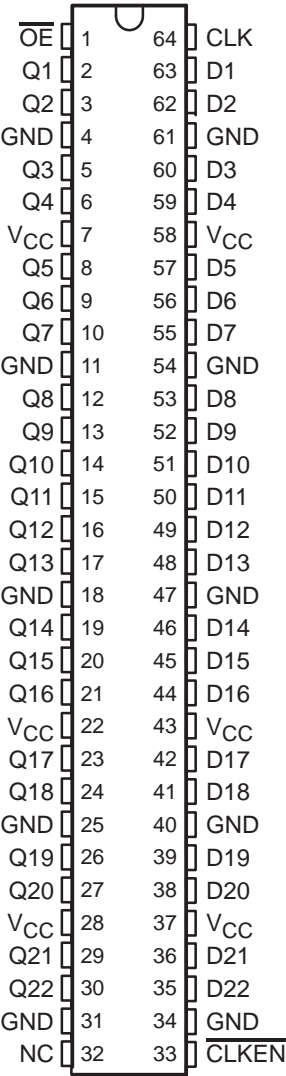
To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

This device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

The SN74AVC16722 is characterized for operation from  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ .

terminal assignments

DGG PACKAGE  
(TOP VIEW)



NC – No internal connection

# SN74AVC16722

## 22-BIT FLIP-FLOP

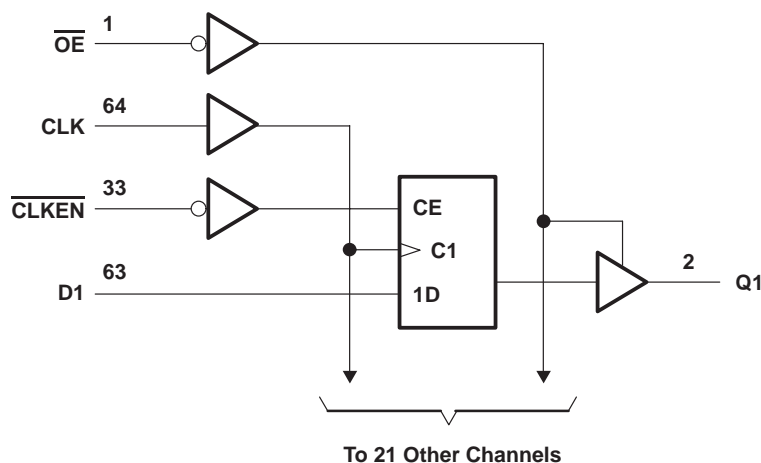
### WITH 3-STATE OUTPUTS

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FUNCTION TABLE  
(each flip-flop)

INPUTS				OUTPUT
$\overline{OE}$	$\overline{CLKEN}$	CLK	D	Q
L	H	X	X	$Q_0$
L	L	$\uparrow$	H	H
L	L	$\uparrow$	L	L
L	L	L or H	X	$Q_0$
H	X	X	X	Z

#### logic diagram (positive logic)



#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage range, $V_{CC}$	–0.5 V to 4.6 V
Input voltage range, $V_I$ (see Note 1)	–0.5 V to 4.6 V
Voltage range applied to any output in the high-impedance or power-off state, $V_O$ (see Note 1)	–0.5 V to 4.6 V
Voltage range applied to any output in the high or low state, $V_O$ (see Notes 1 and 2)	–0.5 V to $V_{CC} + 0.5$ V
Input clamp current, $I_{IK}$ ( $V_I < 0$ )	–50 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ )	–50 mA
Continuous output current, $I_O$	±50 mA
Continuous current through each $V_{CC}$ or GND	±100 mA
Package thermal impedance, $\theta_{JA}$ (see Note 3)	55°C/W
Storage temperature range, $T_{stg}$	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
  2. The output positive-voltage rating may be exceeded up to 4.6 V maximum if the output current rating is observed.
  3. The package thermal impedance is calculated in accordance with JESD 51.

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### WITH 3-STATE OUTPUTS

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#### recommended operating conditions (see Note 4)

		MIN	MAX	UNIT
$V_{CC}$ Supply voltage	Operating	1.4	3.6	V
	Data retention only	1.2		
$V_{IH}$ High-level input voltage	$V_{CC} = 1.2\text{ V}$	$V_{CC}$		V
	$V_{CC} = 1.4\text{ V to }1.6\text{ V}$	$0.65 \times V_{CC}$		
	$V_{CC} = 1.65\text{ V to }1.95\text{ V}$	$0.65 \times V_{CC}$		
	$V_{CC} = 2.3\text{ V to }2.7\text{ V}$	1.7		
	$V_{CC} = 3\text{ V to }3.6\text{ V}$	2		
$V_{IL}$ Low-level input voltage	$V_{CC} = 1.2\text{ V}$		GND	V
	$V_{CC} = 1.4\text{ V to }1.6\text{ V}$		$0.35 \times V_{CC}$	
	$V_{CC} = 1.65\text{ V to }1.95\text{ V}$		$0.35 \times V_{CC}$	
	$V_{CC} = 2.3\text{ V to }2.7\text{ V}$		0.7	
	$V_{CC} = 3\text{ V to }3.6\text{ V}$		0.8	
$V_I$ Input voltage		0	3.6	V
$V_O$ Output voltage	Active state	0	$V_{CC}$	V
	3-state	0	3.6	
$I_{OHS}$ Static high-level output current†	$V_{CC} = 1.4\text{ V to }1.6\text{ V}$		–2	mA
	$V_{CC} = 1.65\text{ V to }1.95\text{ V}$		–4	
	$V_{CC} = 2.3\text{ V to }2.7\text{ V}$		–8	
	$V_{CC} = 3\text{ V to }3.6\text{ V}$		–12	
$I_{OLS}$ Static low-level output current†	$V_{CC} = 1.4\text{ V to }1.6\text{ V}$		2	mA
	$V_{CC} = 1.65\text{ V to }1.95\text{ V}$		4	
	$V_{CC} = 2.3\text{ V to }2.7\text{ V}$		8	
	$V_{CC} = 3\text{ V to }3.6\text{ V}$		12	
$\Delta t/\Delta v$ Input transition rise or fall rate	$V_{CC} = 1.4\text{ V to }3.6\text{ V}$		5	ns/V
$T_A$ Operating free-air temperature		–40	85	°C

† Dynamic drive capability is equivalent to standard outputs with  $I_{OH}$  and  $I_{OL}$  of  $\pm 24\text{ mA}$  at  $2.5\text{-V }V_{CC}$ . See Figure 1 for  $V_{OL}$  vs  $I_{OL}$  and  $V_{OH}$  vs  $I_{OH}$  characteristics. Refer to the TI application reports, **AVC Logic Family Technology and Applications**, literature number **SCEA006**, and **Dynamic Output Control (DOC™) Circuitry Technology and Applications**, literature number **SCEA009**.

NOTE 4: All unused inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

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**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER		TEST CONDITIONS	V <sub>CC</sub>	MIN	TYP†	MAX	UNIT
V <sub>OH</sub>	I <sub>OHS</sub> = −100 μA		1.4 V to 3.6 V	V <sub>CC</sub> −0.2			V
	I <sub>OHS</sub> = −2 mA,	V <sub>IH</sub> = 0.91 V	1.4 V	1.05			
	I <sub>OHS</sub> = −4 mA,	V <sub>IH</sub> = 1.07 V	1.65 V	1.2			
	I <sub>OHS</sub> = −8 mA,	V <sub>IH</sub> = 1.7 V	2.3 V	1.75			
	I <sub>OHS</sub> = −12 mA,	V <sub>IH</sub> = 2 V	3 V	2.3			
V <sub>OL</sub>	I <sub>OLS</sub> = 100 μA		1.4 V to 3.6 V			0.2	V
	I <sub>OLS</sub> = 2 mA,	V <sub>IL</sub> = 0.49 V	1.4 V			0.4	
	I <sub>OLS</sub> = 4 mA,	V <sub>IL</sub> = 0.57 V	1.65 V			0.45	
	I <sub>OLS</sub> = 8 mA,	V <sub>IL</sub> = 0.7 V	2.3 V			0.55	
	I <sub>OLS</sub> = 12 mA,	V <sub>IL</sub> = 0.8 V	3 V			0.7	
I <sub>I</sub>	V <sub>I</sub> = V <sub>CC</sub> or GND		3.6 V			±2.5	μA
I <sub>off</sub>	V <sub>I</sub> or V <sub>O</sub> = 3.6 V		0			±10	μA
I <sub>OZ</sub>	V <sub>O</sub> = V <sub>CC</sub> or GND		3.6 V			±10	μA
I <sub>CC</sub>	V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0		3.6 V			40	μA
C <sub>i</sub>	Control inputs	V <sub>I</sub> = V <sub>CC</sub> or GND	2.5 V	4		pF	
			3.3 V	4			
	Data inputs		2.5 V	2			
			3.3 V	2			
C <sub>O</sub>	Outputs	V <sub>O</sub> = V <sub>CC</sub> or GND	2.5 V	6.5		pF	
			3.3 V	6			

† Typical values are measured at T<sub>A</sub> = 25°C.

**timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figures 2 through 5)**

			V <sub>CC</sub> = 1.2 V		V <sub>CC</sub> = 1.5 V ± 0.1 V		V <sub>CC</sub> = 1.8 V ± 0.15 V		V <sub>CC</sub> = 2.5 V ± 0.2 V		V <sub>CC</sub> = 3.3 V ± 0.3 V		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
f <sub>clock</sub>	Clock frequency						80		140		175	MHz	
t <sub>w</sub>	Pulse duration, CLK high or low						6.2		3.5		2.8	ns	
t <sub>su</sub>	Setup time	Data before CLK↑	12.8		8.3		5.7		3.5		2.5	ns	
		CLKEN before CLK↑	3.5		2		1.6		1.4		1.4		
t <sub>h</sub>	Hold time	Data after CLK↑	0		0		0		0		0	ns	
		CLKEN after CLK↑	2.1		1.6		1.3		1.2		1.2		

**switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figures 2 through 5)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> = 1.2 V		V <sub>CC</sub> = 1.5 V ± 0.1 V		V <sub>CC</sub> = 1.8 V ± 0.15 V		V <sub>CC</sub> = 2.5 V ± 0.2 V		V <sub>CC</sub> = 3.3 V ± 0.3 V		UNIT
			TYP		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
f <sub>max</sub>							80		140		175		MHz
t <sub>pd</sub>	CLK	Q	7.7		1.5	6.3	1.5	5.4	1	3.3	0.7	2.6	ns
t <sub>en</sub>	$\overline{\text{OE}}$	Q	11.2		2.5	10.6	2.4	9.5	1.8	6	1.4	4.3	ns
t <sub>dis</sub>	$\overline{\text{OE}}$	Q	6.8		1.9	7.2	1.9	7	1.2	3.6	1.2	3.4	ns

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### WITH 3-STATE OUTPUTS

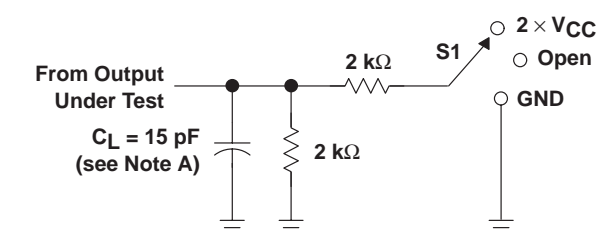
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operating characteristics,  $T_A = 25^\circ\text{C}$

PARAMETER		TEST CONDITIONS	$V_{CC} = 1.8\text{ V}$	$V_{CC} = 2.5\text{ V}$	$V_{CC} = 3.3\text{ V}$	UNIT
			TYP	TYP	TYP	
$C_{pd}$ Power dissipation capacitance	Outputs enabled	$C_L = 0$ , $f = 10\text{ MHz}$	88	98	110	pF
	Outputs disabled		60	64	79	

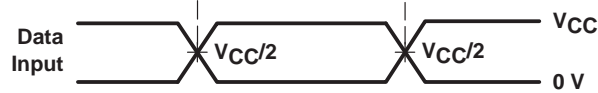
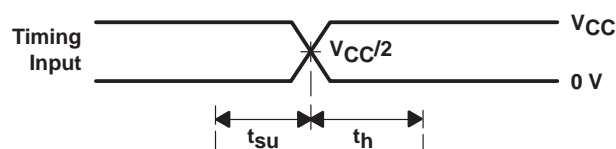
## PARAMETER MEASUREMENT INFORMATION

$V_{CC} = 1.2\text{ V AND } 1.5\text{ V} \pm 0.1\text{ V}$

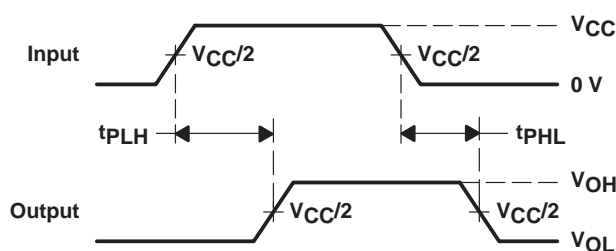


LOAD CIRCUIT

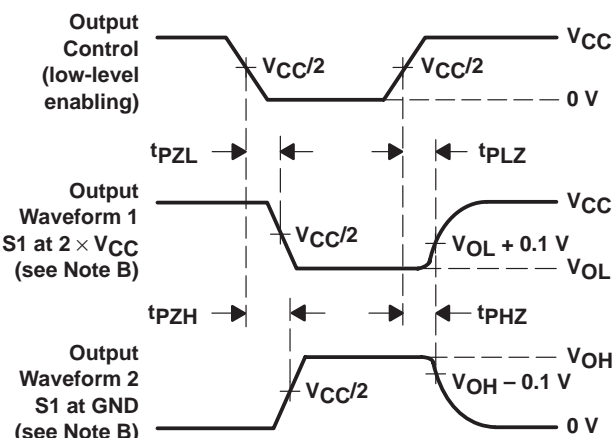
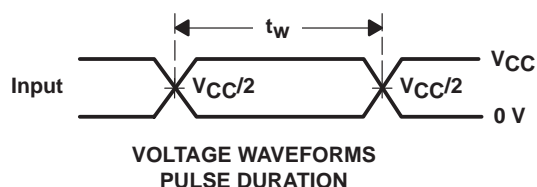
TEST	S1
$t_{pd}$	Open
$t_{PLZ}/t_{PZL}$	2 × $V_{CC}$
$t_{PHZ}/t_{PHZ}$	GND



VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES

- NOTES:
- $C_L$  includes probe and jig capacitance.
  - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r \leq 2\text{ ns}$ ,  $t_f \leq 2\text{ ns}$ .
  - The outputs are measured one at a time with one transition per measurement.
  - $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

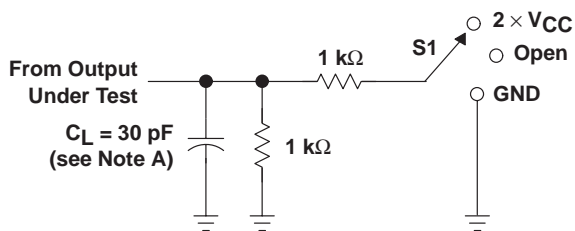
Figure 2. Load Circuit and Voltage Waveforms

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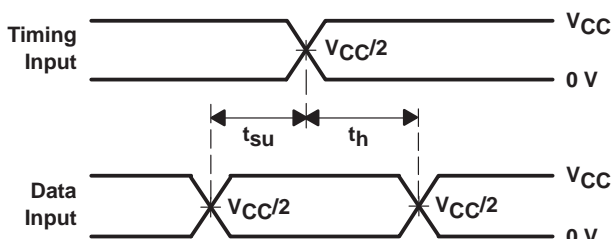
## PARAMETER MEASUREMENT INFORMATION

$$V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$$

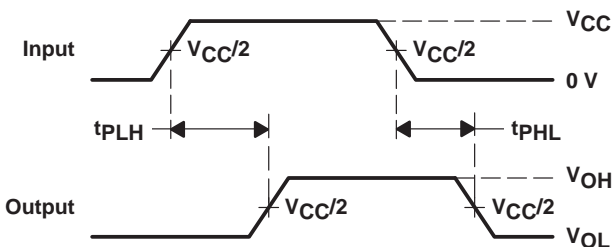


LOAD CIRCUIT

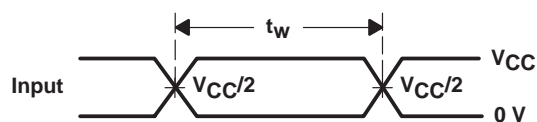
TEST	S1
$t_{pd}$	Open
$t_{PLZ}/t_{PZL}$	2 $\times$ $V_{CC}$
$t_{PHZ}/t_{PZH}$	GND



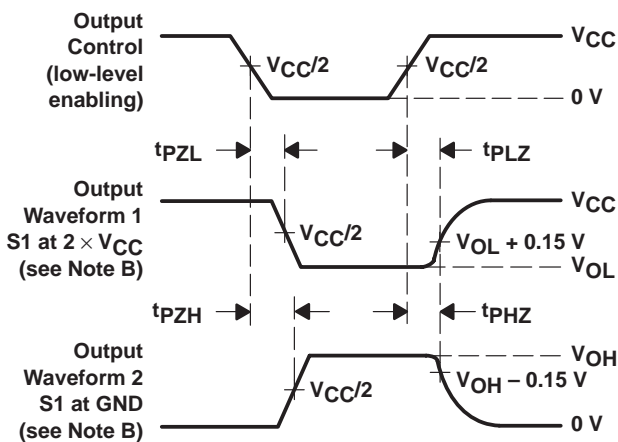
VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES



VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES

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  - The outputs are measured one at a time with one transition per measurement.
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  - $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

Figure 3. Load Circuit and Voltage Waveforms

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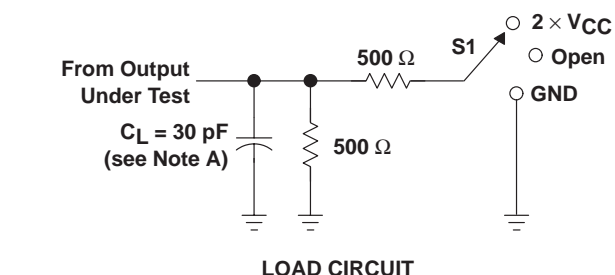
## 22-BIT FLIP-FLOP

### WITH 3-STATE OUTPUTS

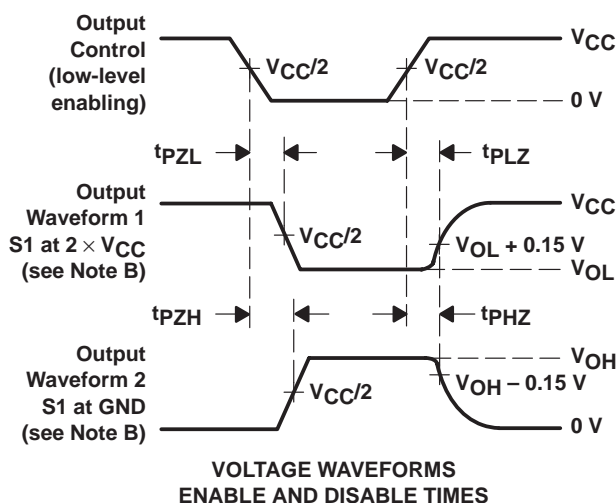
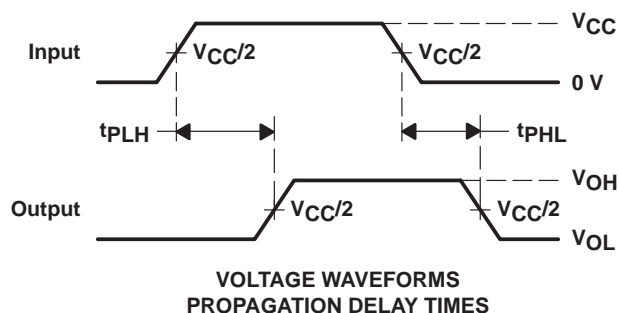
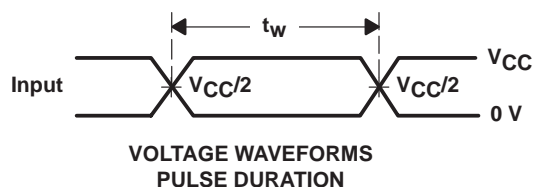
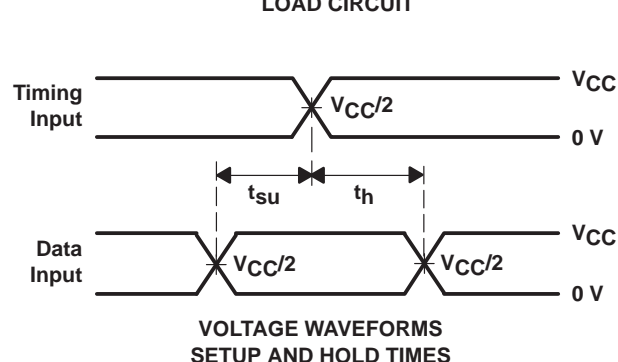
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#### PARAMETER MEASUREMENT INFORMATION

$$V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$$



TEST	S1
$t_{pd}$	Open
$t_{PLZ}/t_{PZL}$	2 $\times V_{CC}$
$t_{PHZ}/t_{PZH}$	GND



- NOTES:
- A.  $C_L$  includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2 \text{ ns}$ ,  $t_f \leq 2 \text{ ns}$ .
  - D. The outputs are measured one at a time with one transition per measurement.
  - E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

Figure 4. Load Circuit and Voltage Waveforms

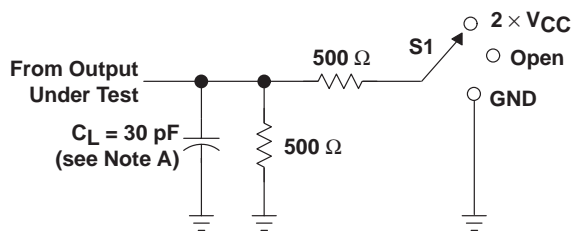


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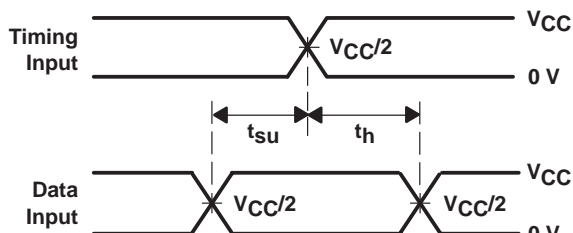
## PARAMETER MEASUREMENT INFORMATION

$$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$$

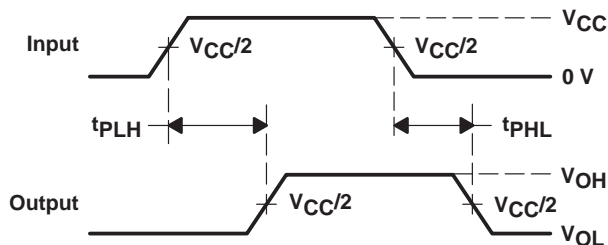


LOAD CIRCUIT

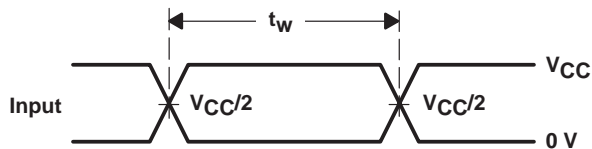
TEST	S1
$t_{pd}$	Open
$t_{PLZ}/t_{PZL}$	2 $\times V_{CC}$
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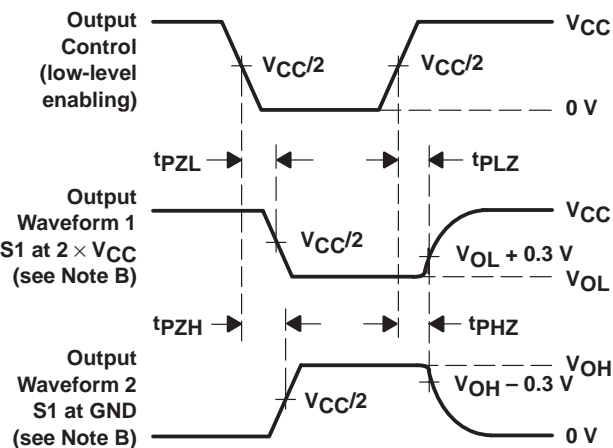
VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES



VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES

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  - $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

Figure 5. Load Circuit and Voltage Waveforms

## PACKAGING INFORMATION

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
74AVC16722DGGRE4	ACTIVE	TSSOP	DGG	64	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AVC16722DGGR	ACTIVE	TSSOP	DGG	64	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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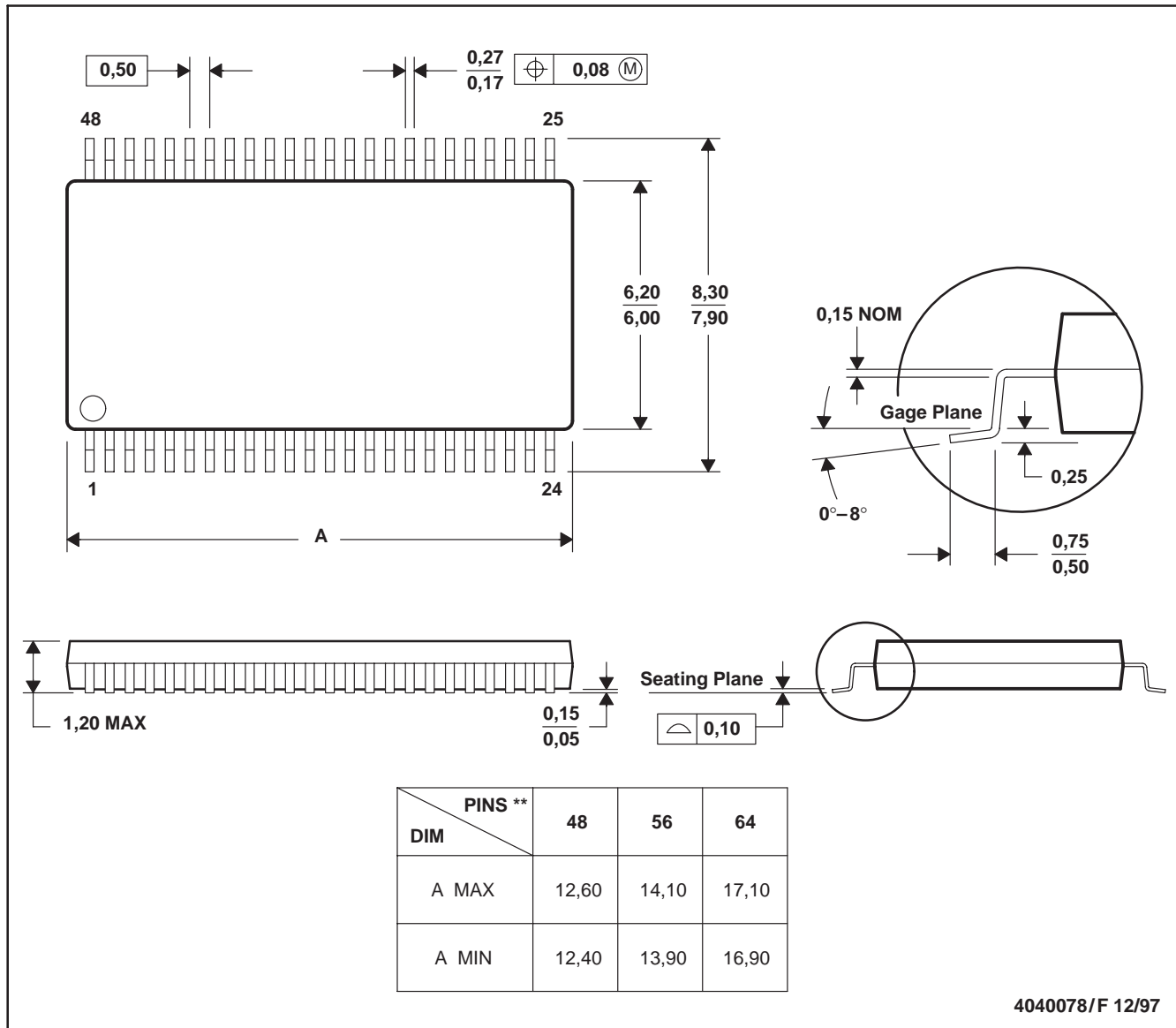
# MECHANICAL DATA

MTSS003D – JANUARY 1995 – REVISED JANUARY 1998

DGG (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

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